

AI Camera Board

MB1854

Table of contents

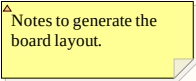
Sheet 1 : Project_Overview
Sheet 2 : MB1854

Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.



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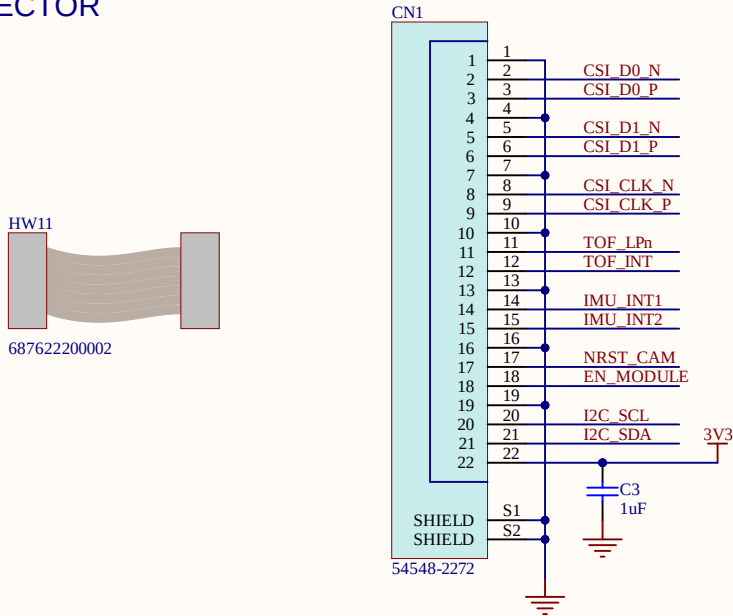
U_MB1854
MB1854.SchDoc



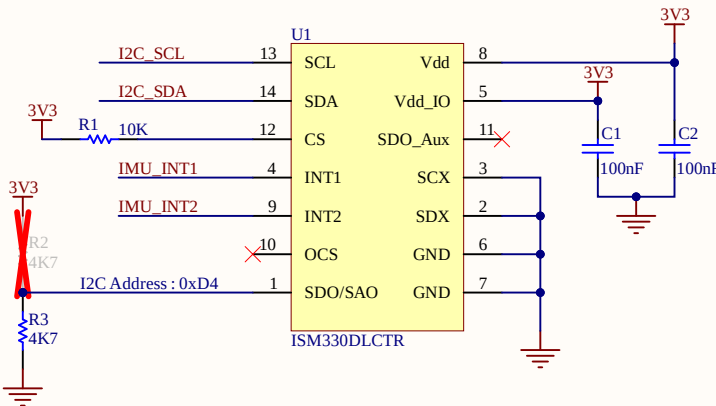
Title: Project_Overview		
Project: AI Camera Board		
Variant: CSI		
Revision: B-02		Reference: MB1854
Size: A4	Date: 22-August-2025	Sheet: 1 of 2



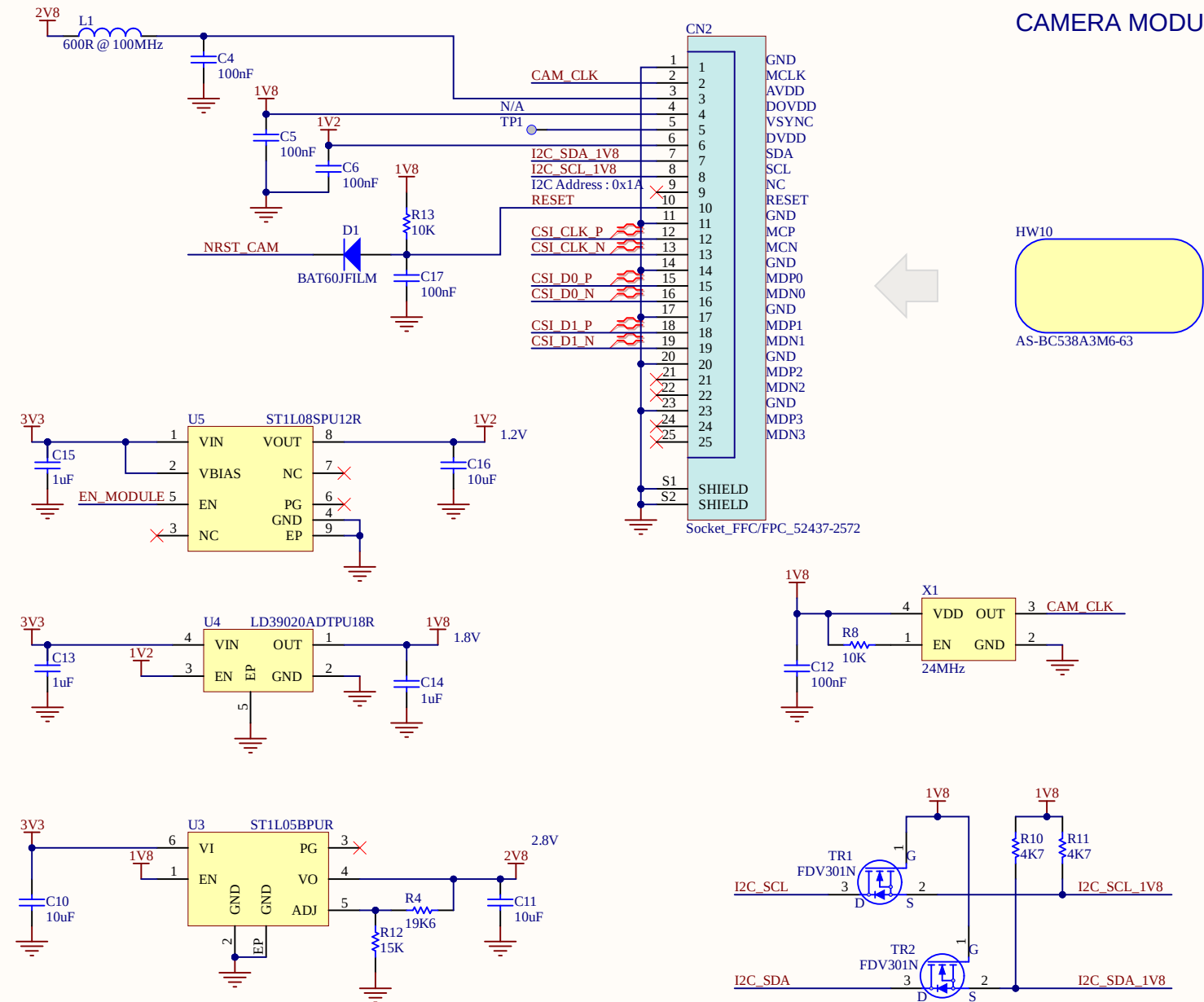
FFC CONNECTOR



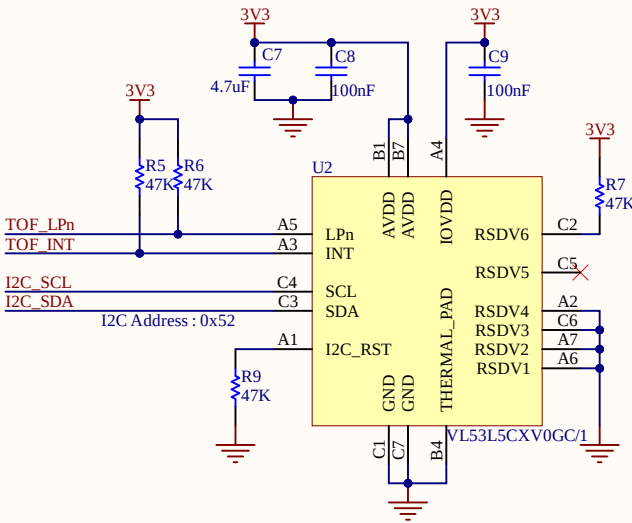
INERTIAL MEASUREMENT UNIT

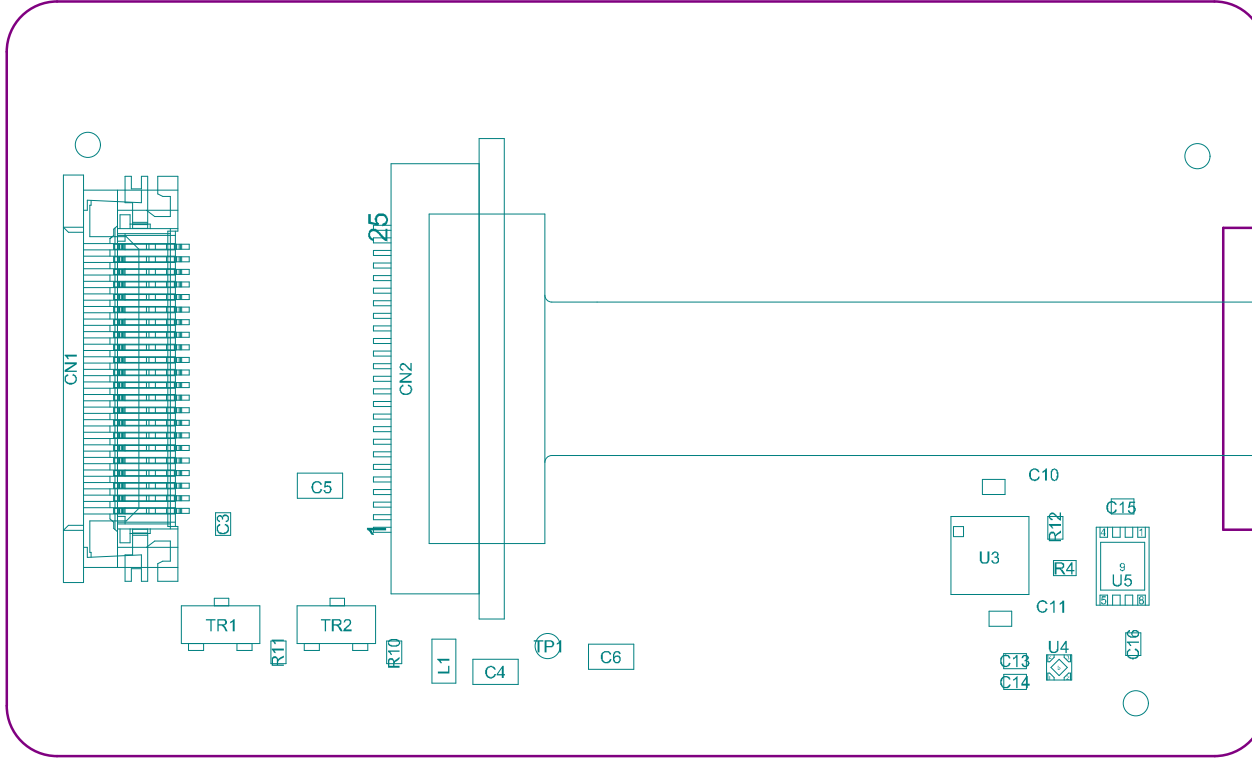


CAMERA MODULE

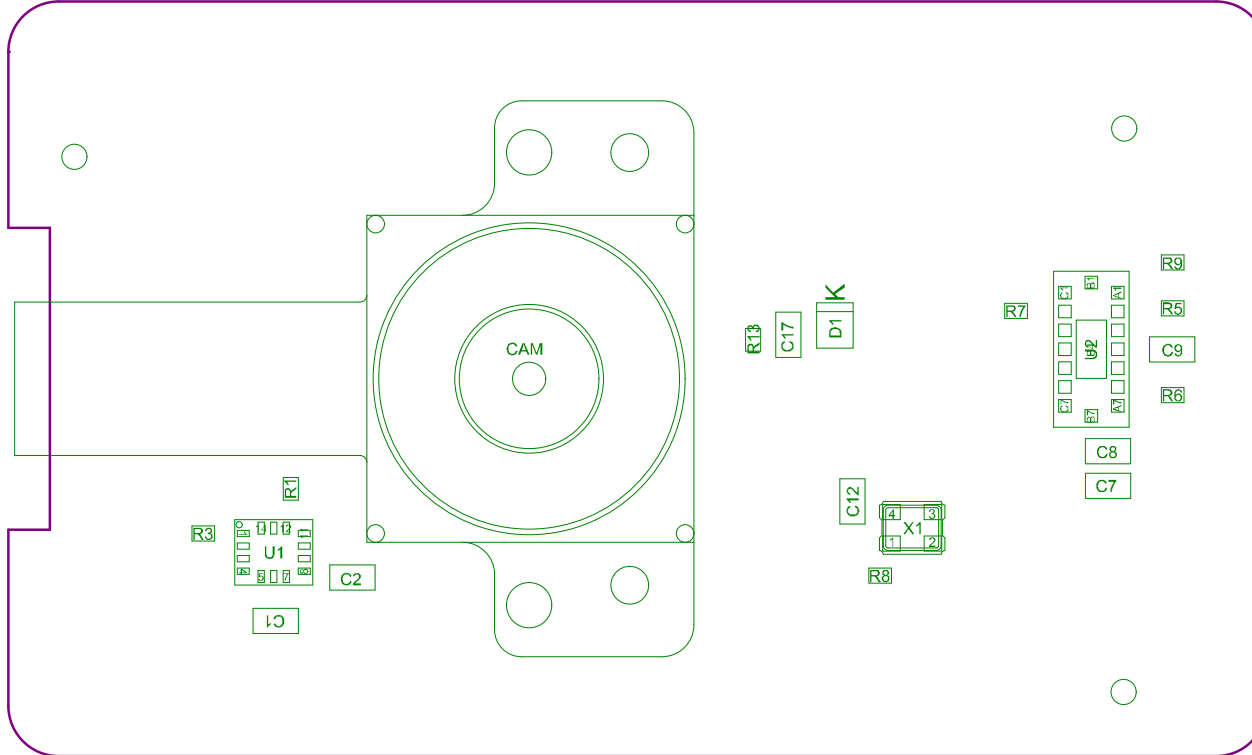


TIME-of-FLIGHT





Project: AI Camera Board		
Layer: M14-Top Assembly	Gerber: .GM14	
Variant: CSI	Ref: MB1854	
Date: 22-09-28	Rev: B	



Project: AI Camera Board		
Layer: M15-Bottom Assembly	Gerber:.GM15	
Variant: CSI	Ref: MB1854	
Date: 22-09-28	Rev: B	